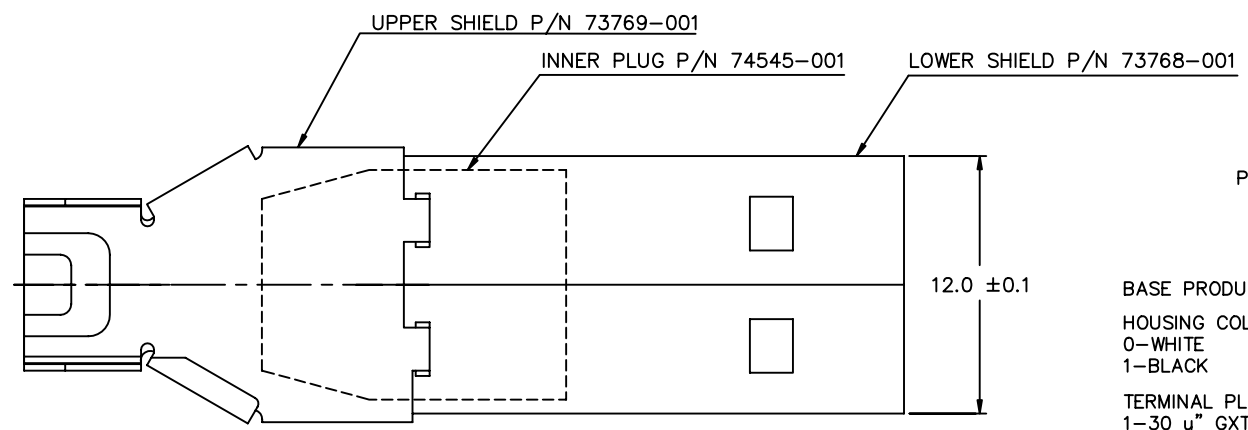
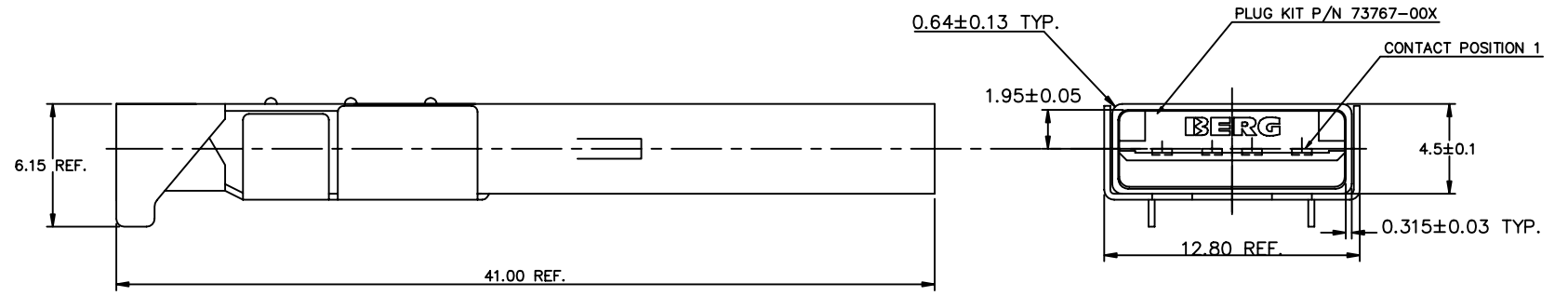


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PRODUCT NO.
74033



PRODUCT NUMBER CODE
7 4 0 3 3 - X 0 X LF

BASE PRODUCT NUMBER
HOUSING COLOR OPTION
0-WHITE
1-BLACK

TERMINAL PLATING OPTION
1-30 u" GXT IN CONTACT AREA
100u" TIN/LEAD IN SOLDER AREA
3-30 u" Au IN CONTACT AREA
100u" TIN/LEAD IN SOLDER AREA

LEAD FREE OPTION
IF LEAD FREE OPTION SELECTED, THE TIN/LEAD PLATING WERE REPLACED BY PURE TIN

- NOTES:
- MATERIAL:
SHIELD: SPCC
CONTACTS : COPPER ALLOY
HOUSING : UL 94V-0 THERMOPLASTIC COLOR: SEE PRODUCT NUMBER CODE
 - CONTACT PLATING : SEE PRODUCT NUMBER CODE
 - SHIELD PLATING : 2.5 um MINIMUM NICKEL.
 - PRINT IS ONLY FOR ASSEMBLY REFERENCE
 - PACKING STANDARD GS-14-920 WILL BE APPLIED FOR LEAD FREE P/N'S
 - FOR LEAD FREE P/N, THE PRODUCT MEET EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008
 - FOR LEAD FREE P/N'S, THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 40 SECONDS IN A HAND SOLDERING OR WAVE SOLDERING PROCESS.

mat'l code		tolerance unless otherwise specified		CUSTOMER COPY	FCJ www.fciconnect.com	
rev.	ecn no.	dr	date	linear	.0 ± 0.3	projection
A	T70418	P P	10/06/97		.00 ± 0.20	
B	T80026	P P	01/20/98		.000 ± 0.10	
C	T80068	P P	02/16/98	angles	± 2°	unit mm scale 4 : 1 A3
D	T80388	P P	08/27/98	dr	PETER 08/14/97	
E	T80579	P P	12/21/98	engr	R Y LIU 08/14/97	
F	N05-0247	P H	08/30/05	chr	R Y LIU 08/14/97	
G	N08-0162	R.B	2008/08/08	appd	JENN TSAO 08/14/97	
sheet	revisor	G				
index	sheet	1				